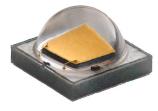
# Cree® XLamp® XP-G2 LEDs



#### **PRODUCT DESCRIPTION**

The XLamp® XP-G2 LED builds on the unprecedented performance of the original XP-G by increasing lumen output up to 20% while providing a single die LED point source for precise optical control. The XP-G2 LED shares the same footprint as the original XP-G, providing a seamless upgrade path and shortening the design cycle.

XLamp XP-G2 LEDs are the ideal choice for lighting applications where high light output and maximum efficacy are required, such as LED light bulbs, outdoor lighting, portable lighting, indoor lighting and solar-powered lighting.

#### **FEATURES**

- Available in white, outdoor white and 80-, 85- and 90-CRI white
- ANSI-compatible chromaticity bins
- Binned at 85 °C
- Maximum drive current: 1500 mA
- Low thermal resistance: 4 °C/W
- Wide viewing angle: 115°
- Unlimited floor life at ≤ 30 °C/85% RH
- Reflow solderable JEDEC J-STD-020C
- Electrically neutral thermal path
- RoHS- and REACh-compliant
- UL<sup>®</sup> recognized component (E349212)



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## **CHARACTERISTICS**

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point	°C/W		4	
Viewing angle (FWHM)	degrees		115	
Temperature coefficient of voltage	mV/°C		-1.8	
ESD withstand voltage (HBM per Mil-Std-883D)	V			8000
DC forward current	mA			1500
Reverse voltage	V			5
Forward voltage (@ 350 mA, 85 °C)	V		2.8	3.15
Forward voltage (@ 700 mA, 85 °C)	V		2.9	
Forward voltage (@ 1000 mA, 85 °C)	V		3.0	
Forward voltage (@ 1500 mA, 85 °C)	V		3.1	
LED junction temperature	°C			150

# **FLUX CHARACTERISTICS** (T<sub>J</sub> = 85 °C)

The following table provides several base order codes for XLamp XP-G2 LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XP Family LEDs Binning and Labeling document.

	CCT Range		Minimum Luminous Flux @ 350 mA		Calculated Minimum Luminous Flux (Im)** @ 85 °C														
Color	Color Min.	Max.	Group	Flux (lm) @ 85 °C	Flux (lm) @ 25 °C*	700 mA	1.0 A	1.5 A	Order Code										
			R3	122	138	223	297	402	XPGBWT-L1-0000-00F51										
Cool White	5000 K	0200 K	R4	130	147	237	316	429	XPGBWT-L1-0000-00G51										
Coor white	5000 K	8300 K	R5	139	158	254	338	458	XPGBWT-L1-0000-00H51										
			S2	148	168	271	360	488	XPGBWT-L1-0000-00J51										
			R2	114	129	208	277	376	XPGBWT-01-0000-00EC2										
	3200 K		R3	122	138	223	297	402	XPGBWT-01-0000-00FC2										
Outdoor White		5300 K	R4	130	147	237	316	429	XPGBWT-01-0000-00GC2										
			R5	139	158	254	338	458	XPGBWT-01-0000-00HC2										
														S2	148	168	271	360	488
			Q5	107	121	195	260	353	XPGBWT-L1-0000-00DE4										
			R2	114	129	208	277	376	XPGBWT-L1-0000-00EE4										
Neutral White	3700 K	5300 K	R3	122	138	223	297	402	XPGBWT-L1-0000-00FE4										
			R4	130	147	237	316	429	XPGBWT-L1-0000-00GE4										
			R5	139	158	254	338	458	XPGBWT-L1-0000-00HE4										
			Q4	100	113	182	243	330	XPGBWT-H1-0000-00CE7										
		000 K 4300 K	Q5	107	121	195	260	353	XPGBWT-H1-0000-00DE7										
80-CRI White	2600 K		R2	114	129	208	277	376	XPGBWT-H1-0000-00EE7										
			R3	122	138	223	297	402	XPGBWT-H1-0000-00FE7										
			R4	130	147	237	316	429	XPGBWT-H1-0000-00GE7										

Notes:

 Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements. See the Measurements section (page 10).

- Typical CRI for Cool White (5000 K 8300 K CCT) is 70.
- Typical CRI for Neutral White (3700 K 5300 K CCT) is 75.
- Typical CRI for Outdoor White (4000 K 5300 K CCT) is 70.
- Typical CRI for Warm White (2600 K 3700 K CCT) is 80.
- \* Flux values @ 25 °C are calculated and for reference only.
- \*\* Calculated flux values at 700 mA, 1 A and 1.5 A are for reference only.
- Minimum CRI for 80-CRI White is 80.
- Minimum CRI for 85-CRI White is 85.
- Minimum CRI for 90-CRI White is 90.

# **FLUX CHARACTERISTICS (T**<sub>J</sub> = 85 °C) - **CONTINUED**

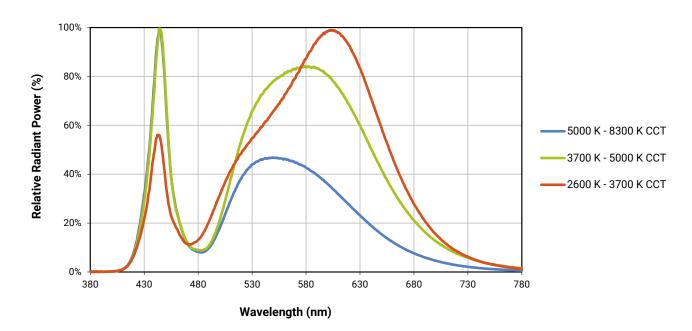
CCT Range		Minimum Luminous Flux @ 350 mA			Calculated Minimum Luminous Flux (lm)** @ 85 °C			Order Code							
Color	Min.	Max.	Group	Flux (lm) @ 85 °C	Flux (lm) @ 25 °C*	700 mA	1.0 A	1.5 A	order Code						
			Q4	100	113	182	243	330	XPGBWT-L1-0000-00CE7						
		К 3700 К	Q5	107	121	195	260	353	XPGBWT-L1-0000-00DE7						
Warm White	te 2600 K		R2	114	129	208	277	376	XPGBWT-L1-0000-00EE7						
			R3	122	138	223	297	402	XPGBWT-L1-0000-00FE7						
			R4	130	147	237	316	429	XPGBWT-L1-0000-00GE7						
			P3	73.9	83.8	135	180	244	XPGBWT-P1-0000-008E7						
			P4	80.6	91.4	147	196	266	XPGBWT-P1-0000-009E7						
85-CRI White	2600 K	2600 K	2600 K	2600 K	2600 K	2600 K	2600 K	3200 K	Q2	87.4	99.1	160	213	288	XPGBWT-P1-0000-00AE7
			Q3	93.9	106	172	228	310	XPGBWT-P1-0000-00BE7						
			Q4	100	113	182	243	330	XPGBWT-P1-0000-00CE7						
			P3	73.9	83.8	135	180	244	XPGBWT-U1-0000-008E7						
	2600 K	00 K 3200 K	P4	80.6	91.4	147	196	266	XPGBWT-U1-0000-009E7						
90-CRI White			Q2	87.4	99.1	160	213	288	XPGBWT-U1-0000-00AE						
			Q3	93.9	106	172	228	310	XPGBWT-U1-0000-00BE7						
			Q4	100	113	182	243	330	XPGBWT-U1-0000-00CE7						

Notes:

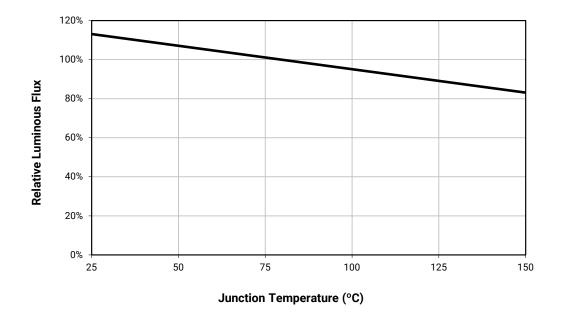
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- Typical CRI for Warm White (2600 K 3700 K CCT) is 80.
- \* Flux values @ 25 °C are calculated and for reference only.
- \*\* Calculated flux values at 700 mA, 1 A and 1.5 A are for reference only.
- Minimum CRI for 80-CRI White is 80.
- Minimum CRI for 85-CRI White is 85.
- Minimum CRI for 90-CRI White is 90.

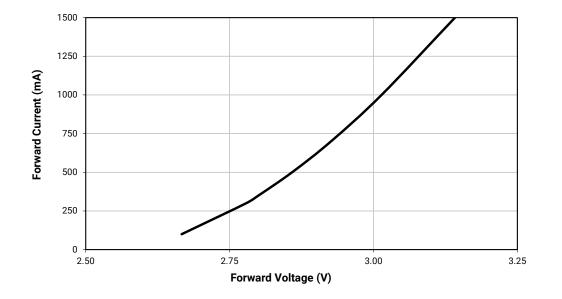
## **RELATIVE SPECTRAL POWER DISTRIBUTION**



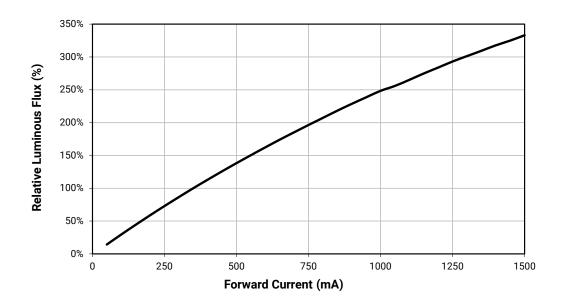
## **RELATIVE FLUX VS. JUNCTION TEMPERATURE** ( $I_F = 350 \text{ mA}$ )



## **ELECTRICAL CHARACTERISTICS** ( $T_J = 85 °C$ )



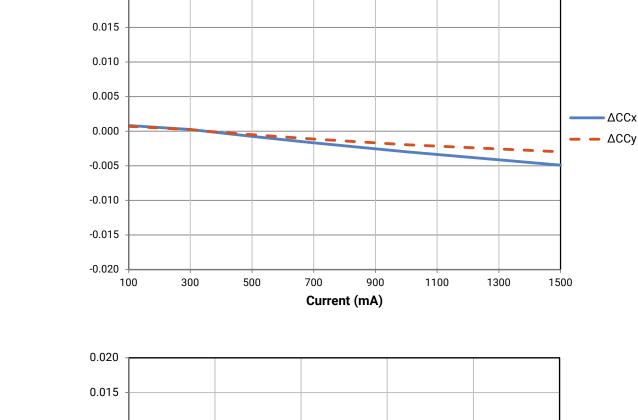
## **RELATIVE FLUX VS. CURRENT** ( $T_{J}$ = 85 °C)



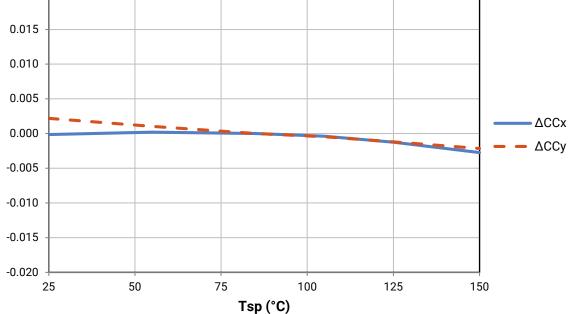
- ∆CCx



0.020

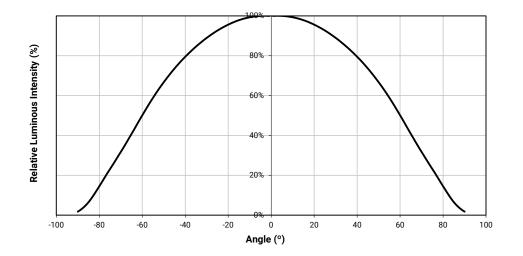


## **RELATIVE CHROMATICITY VS CURRENT AND TEMPERATURE (WARM WHITE\*)**



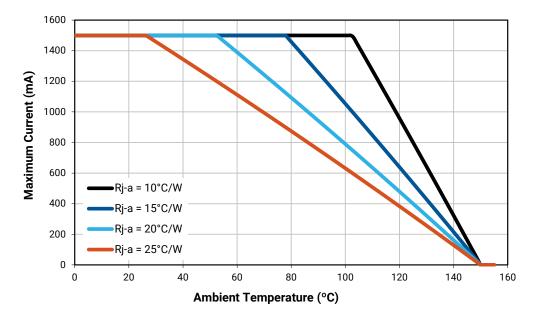
\* Warm White XLamp XP-G2 LEDs have a typical CRI of 80.

## **TYPICAL SPATIAL DISTRIBUTION**



## **THERMAL DESIGN**

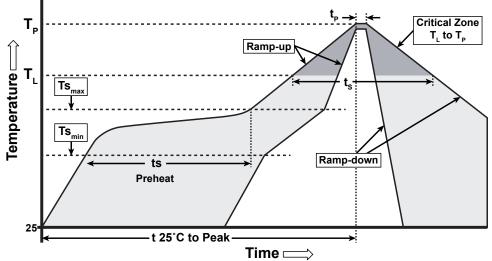
The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.



## **REFLOW SOLDERING CHARACTERISTICS**

In testing, Cree has found XLamp XP-G2 LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of the solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



IPC/JEDEC J-STD-020C

Profile Feature	Lead-Free Solder
Average Ramp-Up Rate (Ts $_{max}$ to T $_{p}$ )	1.2 °C/second
Preheat: Temperature Min (Ts <sub>min</sub> )	120 °C
Preheat: Temperature Max (Ts <sub>max</sub> )	170 °C
Preheat: Time (ts <sub>min</sub> to ts <sub>max</sub> )	65-150 seconds
Time Maintained Above: Temperature $(T_L)$	217 °C
Time Maintained Above: Time ( $t_L$ )	45-90 seconds
Peak/Classification Temperature (Tp)	235 - 245 °C
Time Within 5 °C of Actual Peak Temperature (tp)	20-40 seconds
Ramp-Down Rate	1 - 6 °C/second
Time 25 °C to Peak Temperature	4 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.

#### **NOTES**

#### Measurements

The luminous flux, radiant power, chromaticity and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended as specifications.

#### Lumen Maintenance

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document.

Please read the Long-Term Lumen Maintenance application note for more details on Cree's lumen maintenance testing and forecasting. Please read the Thermal Management application note for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

#### **Moisture Sensitivity**

Cree recommends keeping XLamp LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain XLamp LEDs do not need special storage for moisture sensitivity.

Once the MBP is opened, XLamp XP-G2 LEDs may be stored as MSL 1 per JEDEC J-STD-033, meaning they have unlimited floor life in conditions of  $\leq$  30 °C/85% relative humidity (RH). Regardless of the storage condition, Cree recommends sealing any unsoldered LEDs in the original MBP.

#### **RoHS Compliance**

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree representative or from the Product Documentation sections of www.cree.com.

#### **REACh Compliance**

REACh substances of very high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACh Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

#### **UL® Recognized Component**

Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/ UL 8750.

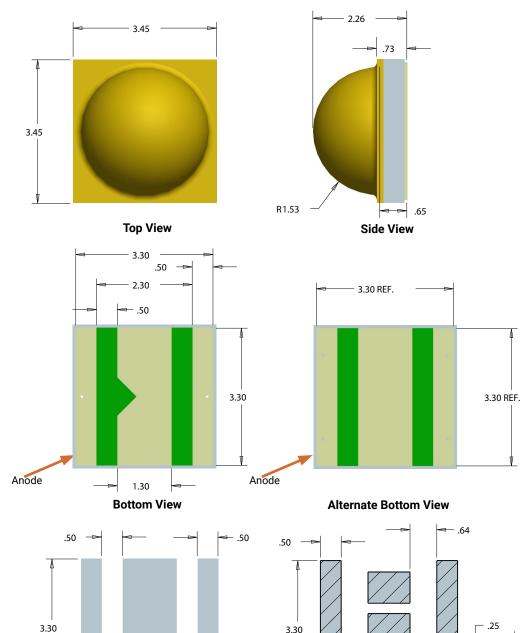


## **NOTES - CONTINUED**

#### **Vision Advisory**

WARNING: Do not look at an exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the LED Eye Safety application note.

## **MECHANICAL DIMENSIONS** ( $T_{A} = 25 \text{ °C}$ )



All measurements are ±.13 mm unless otherwise indicated.

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- 1.30

- 3.30

**Recommended PCB Solder Pad** 

3.30

1.01

2.30

3.30 **Recommended Stencil Pattern** 

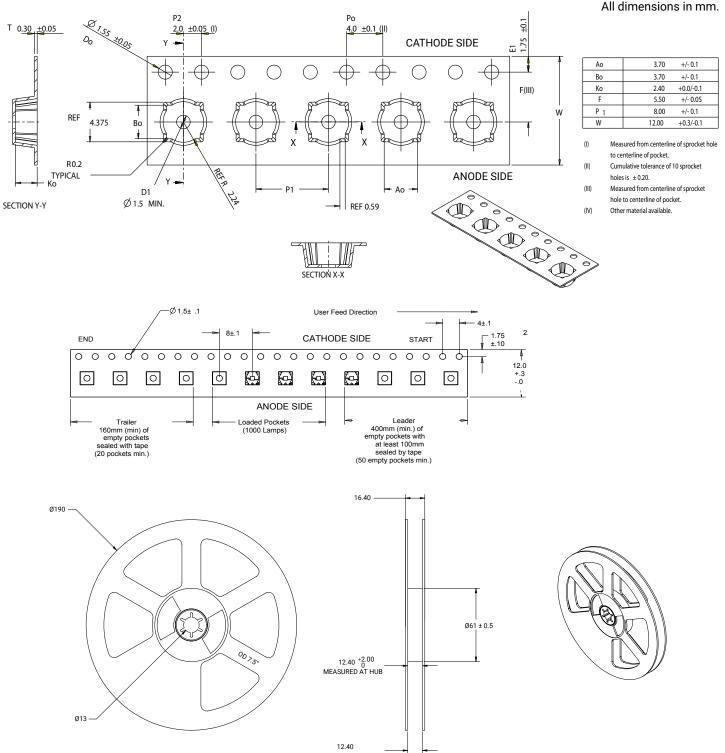
(Hatched Area is Open)

.75



#### **TAPE AND REEL**

All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.



MEASURED AT INSIDE EDGE



### PACKAGING

